

# SPECIFICATION FOR APPROVAL

CUSTOMER : \_\_\_\_\_

PRODUCT TYPE : SMD GLASS SEALING XTAL 3.2 × 2.5

NOMINAL FREQ. : 12.288000MHz

TXC P/N : 7V12200001

REVISION : S1

CUSTOMER P/N : \_\_\_\_\_

PM / SALES : \_\_\_\_\_

DATE : \_\_\_\_\_

CUSTOMER SIGNATURE & Date \_\_\_\_\_

\_\_\_\_\_

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

**MSL:Level 1**  
**RoHS Compliant**

Pb used in sealing glass material is exempt from EU directive

# PRODUCT SPECIFICATION SHEET

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PE/RD	QA	MFG
<i>Robin Huang</i>		
<i>5-Jul-10</i>		

**NOTE:**

- (1)Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).
- (2)Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3)Revision "Ax" is production ready. PE, QA and MFG's approval required

**MSL:Level 1  
RoHS Compliant**

Pb used in sealing glass material is exempt from EU directive

<u>Rev</u>	<u>Revise page</u>	<u>Revise contents</u>	<u>Date</u>	<u>Ref.No.</u>	<u>Reviser</u>
S1	N/A	Initial released	5-Jul-10	N/A	Xiaoyan Jiang

## Spec Sheet Contents

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**ELECTRICAL SPECIFICATIONS****Standard atmospheric conditions**

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : 25±5  
Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : 25±3  
Relative humidity : 40%~70%

**Measure equipment**

Electrical characteristics measured by S&A250B or equivalent.

**Crystal cutting type**

The crystal is using AT CUT (thickness shear mode).

**Unit Weight:**

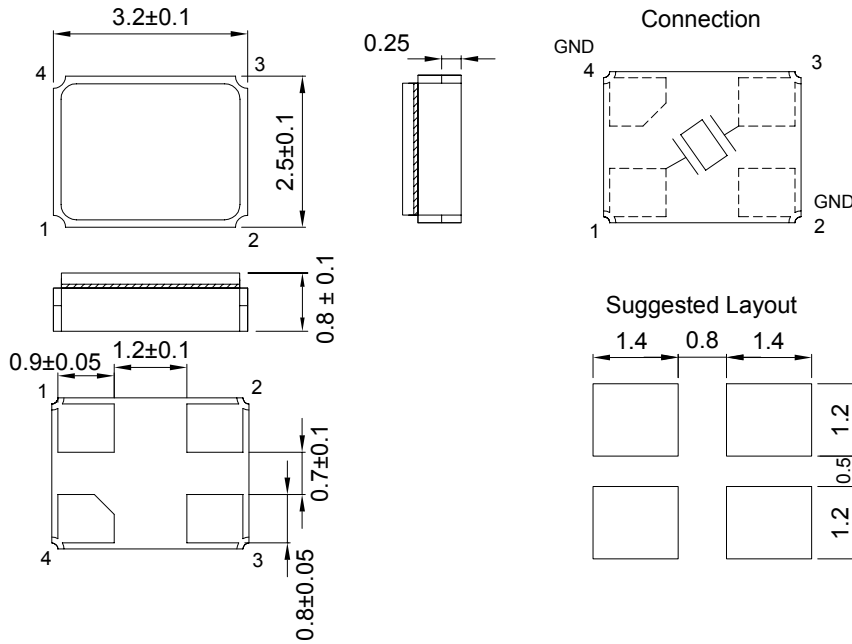
0.018±0.001 g/pcs

	Parameters	SYM.	Electrical Spec.				Notes
			MIN	TYP	MAX	UNITS	
1	Nominal Frequency	FL	12.288000			MHz	-
2	Oscillation Mode	-	Fundamental			-	-
3	Load Capacitance	CL	12			pF	-
4	Frequency Tolerance	-	±30			ppm	at 25 ± 3 °C
5	Frequency Stability	-	±30			ppm	Over Operating Temp. Range (Reference 25 °C)
6	Operating Temperature	-	-40	~	85	°C	-
7	Aging	-	±3			ppm	1st Year
8	Drive Level	DL	-	100	-	uW	-
9	Equivalent Resistance Rr	Rr	-	-	100	Ω	-
10	Shunt Capacitance C0	C0	-	-	-	pF	-
11	Insulation Resistance	-	500	-	-	MΩ	at DC 100V
12	Storage Temperature Range	-	-40	~	85	°C	-

**FACTORY LOCATION**

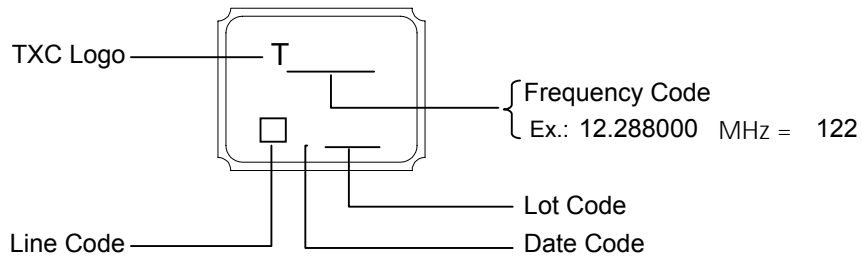
TXC (NINGBO) CORPORATION  
NO.189 Huang Shan West Road, Beilun District,  
Ningbo Zhejiang China

**■ DIMENSIONS**  
(Unit:mm)



\*Coplanarity of solderable areas Camber 0.10 mm Max

**■ MARKING**



**Date Code:**

YEAR \ MONTH				MONTH											
				JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2005	2009	2013	2017	A	B	C	D	E	F	G	H	J	K	L	M
2006	2010	2014	2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2007	2011	2015	2019	a	b	c	d	e	f	g	h	j	k	l	m
2008	2012	2016	2020	n	p	q	r	s	t	u	v	w	x	y	z

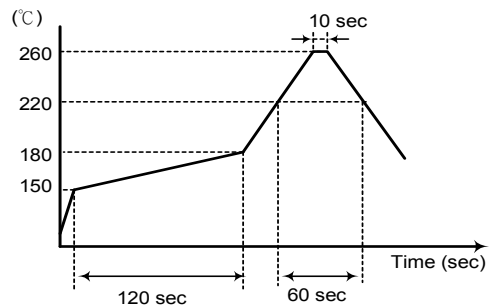
\*This date code will be cycled every four years

**■ SUGGESTED REFLOW PROFILE**

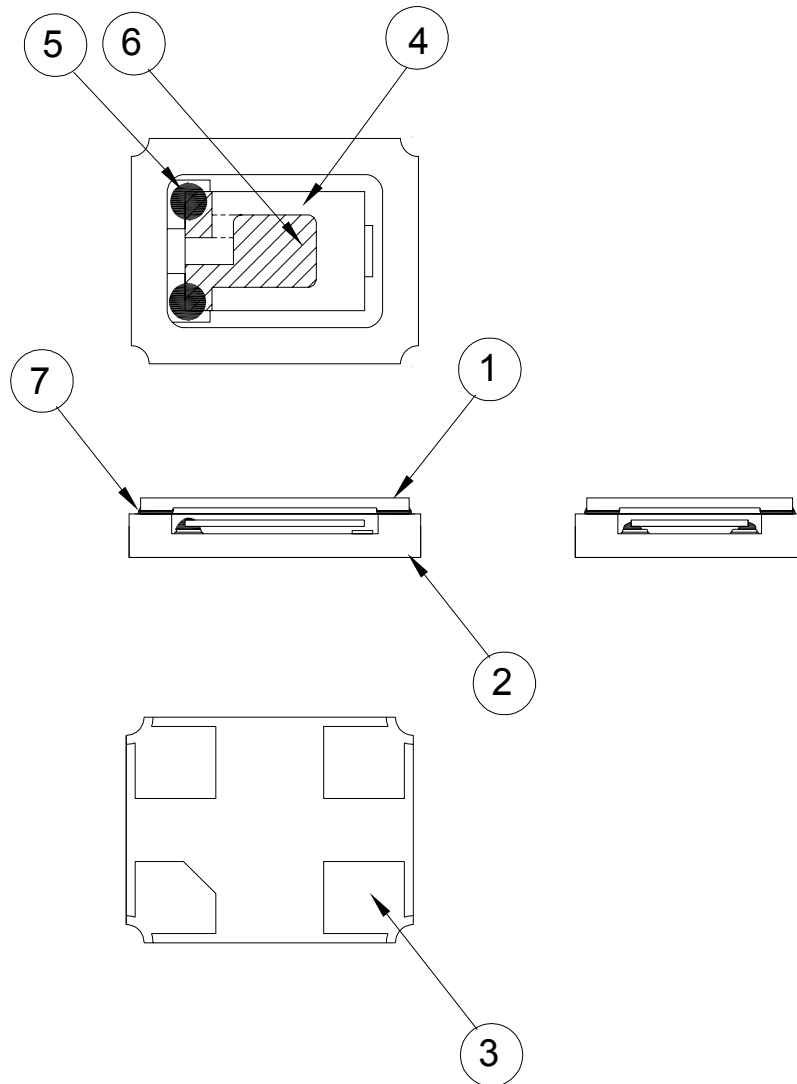
Solder melting point :220±10 °C, 60 sec. Min.  
Peak Temperature: 260 ± 5 °C, 10 sec. Max.

**■ SUGGESTED MANUAL SOLDER CONDITION**

Temperature: 350 ± 10 °C  
Time: 3 sec.  
Re-solder times: twice

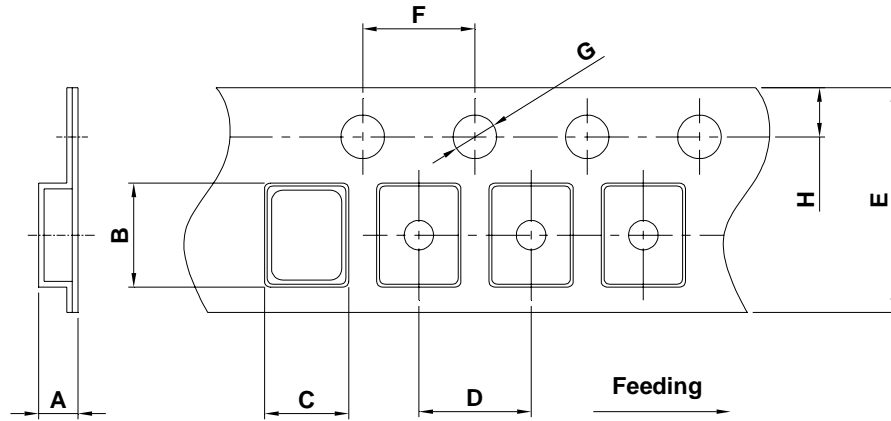


■ STRUCTURE ILLUSTRATION



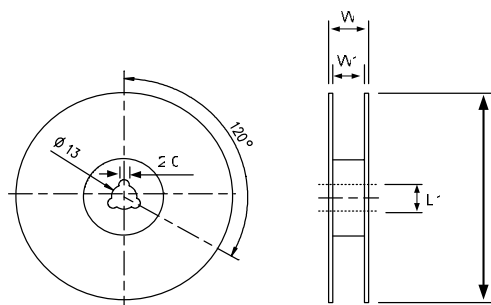
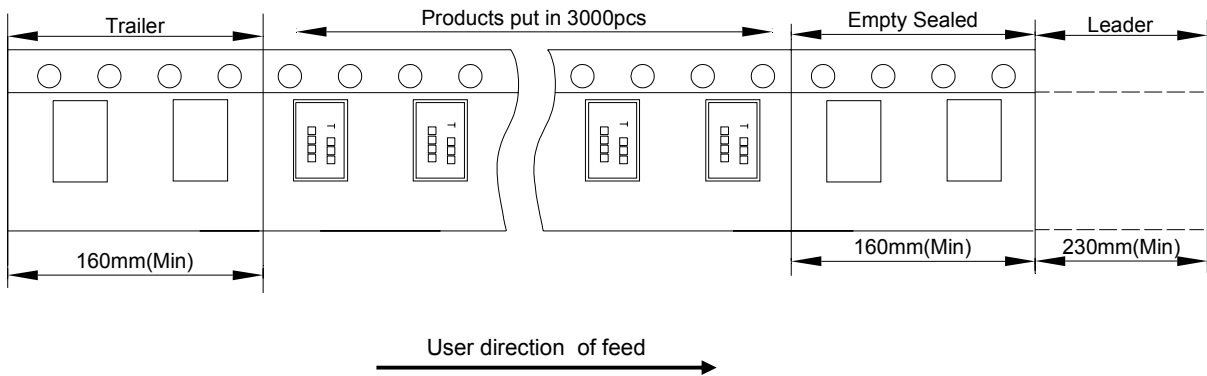
NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Cap	Ceramic (Al <sub>2</sub> O <sub>3</sub> )	-
2	Package	Ceramic (Al <sub>2</sub> O <sub>3</sub> )	-
3	PAD	Au	Tungsten metalize + Ni plating + Au plating
4	Crystal blank	SiO <sub>2</sub>	-
5	Conductive adhesive	Resin+Ag	-
6	Electrode	Ag	-
7	Sealing Glass	Glass(PbO)	-

■ **EMBOSS CARRIER TAPE & REEL**



DIMENSIONS	A	B	C	D	E	F	G	H	
	1.65±0.10	3.40±0.10	2.70±0.10	4.00±0.10	8.00±0.20	4.00±0.10	1.55±0.10	1.75±0.10	(UNIT : mm)

REMARK :



DIMENSIONS	L	L1	W	W1	
	178±1.00	13±0.50	11.5±0.20	8±0.10	(UNIT : mm)



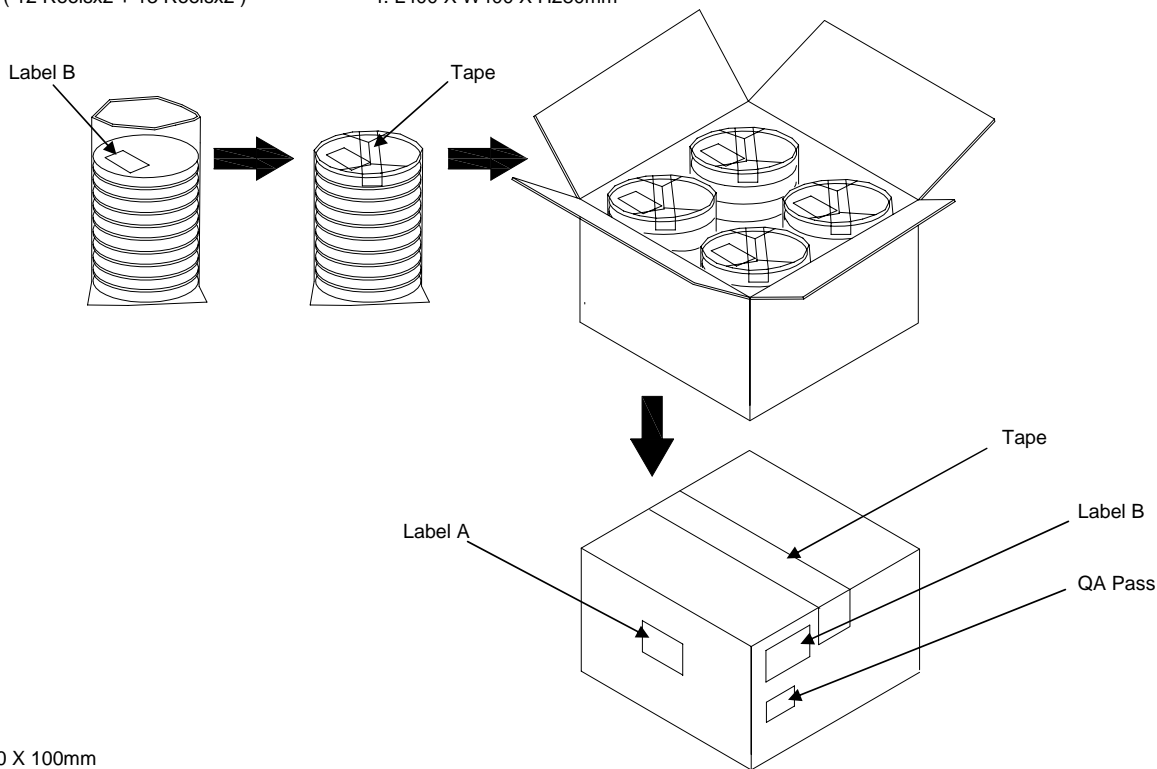
**PACKING**

Reel Quantity :

- 1. Reel X 6 (6 Reels)
- 2. Reel X 12 (12 Reels)
- 3. Reel X 25 (12 Reels + 13 Reels)
- 4. Reel X 50 (12 Reelsx2 + 13 Reelsx2)

Box Size:

- 1. L200 X W200 X H140mm
- 2. L200 X W200 X H250mm
- 3. L400 X W200 X H250mm
- 4. L400 X W400 X H280mm



(Label A) Size:100 X 100mm

<b>NO:</b>	
<b>P/O:</b>	-
<b>P/N:</b>	
<b>NUM:</b>	PCS

(Label B) Size:80 X 40mm

<b>TXC CORPORATION</b>		QC PASS XXXX/XX/XX
DATE CODE:		
LOT NO:	Q'TY:	
PARTS NO:		
FREQ:		

**[STORAGE]**

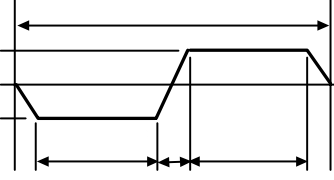
- 1.The storage time to be 1 year maximum.
- 2.Don't be caught in the rain.
- 3.The storage environment shall be 5 ~40 temperature and 30% ~ 75%RH humidity and free from the sun shine.
- 4.If costumers have special requirements, we can paste labels according to it.

**RELIABILITY SPECIFICATIONS**

1.Mechanical Endurance

No.	Test Item	Test Methods	Test Criteria
1.1	Drop Test	100 cm height,3 times on concrete floor .	A . C
1.2	Mechanical Shock	Device are shocked to half sine wave ( 1000 G ) three mutually perpendicular axes each 3 times. 0.5 ms duration time	A . C
1.3	Vibration	Frequency range 10 ~ 2000 Hz Amplitude 1.52 mm/20G Sweep time 20 minutes Perpendicular axes each test time 4 Hrs (Total test time 12 Hrs)	A . C
1.4	Solderability	Temperature 245 ± 5 Immersing depth 0.5 mm minimum Immersion time 5 ± 1 seconds Flux Rosin resin methyl alcohol solvent ( 1 : 4 )	E

2.Environmental Endurance

No.	Test Item	Test Methods	Test Criteria
2.1	Resistance To Soldering Heat	Pre-heat temperature 125 Pre-heat time 60 ~ 120 sec. Test temperature 260 ± 5 Test time 10 ± 1 sec.	B . C . D
2.2	High Temp. Storage	+ 125 ± 3 for 500 ± 12 Hrs	B . C . D
2.3	Low Temp. Storage	- 40 ± 3 for 500 ± 12 Hrs	B . C . D
2.4	Thermal Shock	Total 100 cycles of the following temperature cycle 	B . C . D
2.5	High Temp & Humidity	85 ± 3 , RH 85% , 500 Hrs	B . C . D
2.6	Pressure Cooker Storage	121 ± 3 , RH100% , 2 bar , 240 Hrs	B . C . D



**RELIABILITY SPECIFICATIONS**

Specifications	
A	Frequency change: Within $\pm 5$ ppm or in customer's specification.
B	Frequency change: Within $\pm 10$ ppm or in customer's specification.
C	Equivalent series resistance(E.S.R) change: Within $\pm 15\%$ or $5\Omega$ (larger value).
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 2 hour, and measured.
E	Minimum 95% of immersed terminal shall be covered with new uniform solder.

**Measurement condition**

Electrical characteristics measured by S&A250B or equivalent.